

AP8048A Datasheet

Audio Application Processor
(ARM Cortex-M3 based)

Rev1.0

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Revision History

Date	Revision	Description
2013-11-26	V0.5	Change pin assignment
2014-3-12	V0.6	Change pin18's name
2014-3-18	V0.7	Change power supply voltage value
2014-04-11	V0.8	Add the pin function table, LDO330 V-I chart and the store/reflow requirements
2016-01-18	V0.9	Revised the description of the chip features
2016-03-20	V1.0	Add the Codec's functional block

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1. Overview

As a highly integrated SoC for audio application processing, AP8048A integrates ARM Cortex-M3, OTG, SD/MMC card controller, SARADC, audio DAC, audio ADC, RTC and IR decoder in a single chip. The firmware enables AP8048A to further support Bluetooth stack, various audio decoders, encoders, and effects. In general AP8048A offers low power consumption, flexible and more powerful wireless audio player solution.

1.1 Features

- ARM 32-bit Cortex-M3 core with frequency up to 96 MHz
- 128KBytes of SRAM
- 32KBytes fast cache to interface with external SPI-flash
- Code encryption/decryption mechanism for SPI-flash
- Embedded LDO with 3.3V output
- Low power RTC with NVM
- USB full-speed OTG controller
- SD/MMC card controller
- High speed UART with flow control
- Multiple PWM outputs
- 12-bit SARADC
- IR (NEC) decoder
- Multiple GPIOs for various purposes
- FAT16/FAT32 file system
- Bluetooth stack including A2DP, AVRCP, HFP, SPP, OBEX etc
- Audio input and output
 - Stereo 20-bit high quality Audio DAC, SNR ≥ 95 dB
 - Stereo 16-bit high quality Sigma Delta ADC, SNR ≥ 90 dB
 - Programmable preamp gain for input from microphone and line-in
 - Programmable ALC / Noise Gate
 - Built-in headphone driver
 - ◆ >40 mW output power into 16Ω / 3.3V
 - ◆ THD -80 dB at 20mW, SNR 90dB with 16Ω load
 - Tone generator
 - 9 sample rates supported: 8kHz, 11.025 kHz, 12 kHz, 16 kHz, 22.05 kHz, 24 kHz, 32 kHz, 44.1 kHz, 48kHz
- Audio Algorithms

- Decoders: MP2/MP3, WMA, FLAC(8/16/24bit), AAC/MP4/M4A, WAV(IMA-ADPCM and raw PCM), AIF, AIFC
- Encoder: MP2/MP3, IMA-ADPCM
- Effects:
 - ◆ Echo
 - ◆ Reverb
 - ◆ MV3D
 - ◆ MVBASS
 - ◆ Pitch shifter
 - ◆ Parametric EQ
 - ◆ Dynamic Range Compression (DRC)
 - ◆ Acoustic Echo Cancellation (AEC)
 - ◆ Programmable frequency shifter for howling prevention
 - ◆ Fast and accurate howling detection and suppression
- Serial wire debug (SWD) interface
- Firmware updatable through SD/USB drive

1.2 CODEC Functional Block

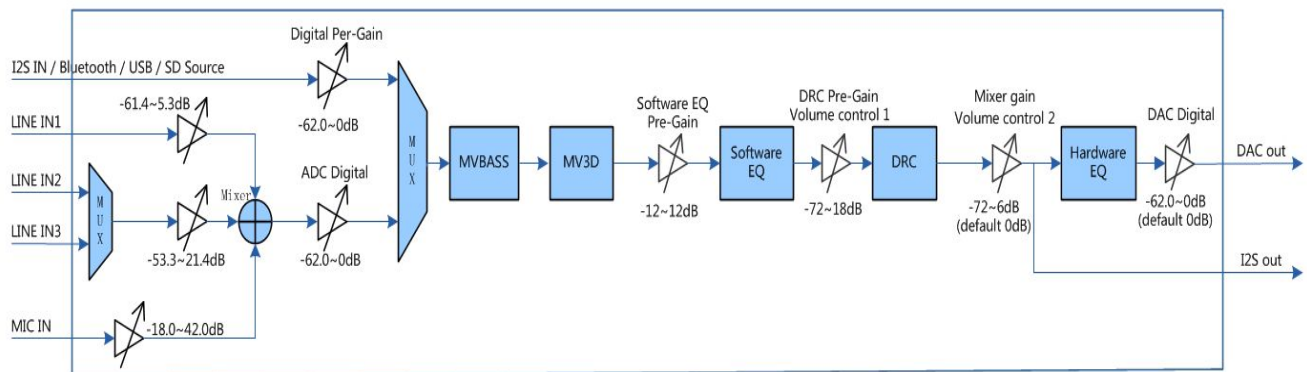


Figure 1 CODEC Functional Block

Notes.

1. Adjust the system volume either through DRC pre-gain (DRC on) or mixer gain (DRC off).
2. Direct control of DAC digital volume is NOT recommended.

2. Pin Description

AP8048A is a CMOS device. Floating level on input signals causes unstable device operation and abnormal current consumption. Pull-up or Pull-down resistors should be used appropriately for input or bidirectional pins.

Notation	Description
I	Input
O	Output
I/O	Bidirectional
PWR	Power
GND	Ground

2.1 Pin Description

Table 1 Pin Description

Pin name	Pin #	Type	Description
Audio CODEC interface pins			
DAC_R	8	AO	audio right channel output
DAC_L	9	AO	audio left channel output
DACVMID	7	AI	Internal voltage reference
MICIN	11	AI	MIC input
GPIO/MCU IO pins			
GPIO_A[10]	20	I/O	GPIO PORT, bank A
GPIO_A[25:13]	33:21	I/O	GPIO PORT, bank A
GPIO_B[8:5]	37:34	I/O	GPIO PORT, bank B
GPIO_B[20]	39	I/O	GPIO PORT, bank B
GPIO_B[29:22]	47:40	I/O	GPIO PORT, bank B
GPIO_B[31]	48	I/O	GPIO PORT, bank B
GPIO_C[0]	1	I/O	GPIO PORT, bank C
GPIO_C[14:11]	5:2	I/O	GPIO PORT, bank C
CLK pins			
XIN	12	I	32.768KHz Crystal oscillator input for PLL
XOUT	13	O	32.768KHz Crystal oscillator output for PLL
Power/Ground pins			
DVSS	19	GND	ground for digital
LDOIN	15	PWR	LDO power in
LDO33O	14	PWR	LDO 3.3V out
LDO12O	17	PWR	LDO 1.2V out
IOVDD	38	PWR	IO 3.3V
RTCVDD	18	PWR	power for RTC
DACVDD	10	PWR	power for DAC
DACAVSS	6	GND	ground for DAC
MISC pins			
POWER_KEY	16	I	Power Key

Table 2 GPIO Pin Function

Pin Name	Other Function Assignment
GPIO_A[10]	IR0 / PWC0 / PWM3 / WAKEUP
GPIO_A[13]	FSH_HOLD
GPIO_A[14]	FSH_SCK
GPIO_A[15]	FSH_SI
GPIO_A[16]	FSH_WP
GPIO_A[17]	FSH_SO
GPIO_A[18]	FSH_CS

GPIO_A[19]	SD1_DAT / SPIM1_MISO
GPIO_A[20]	SD1_CLK / SPIM1_CLK
GPIO_A[21]	SD1_CMD / SPIM1_MOSI
GPIO_A[22]	USB2_DP
GPIO_A[23]	USB2_DM
GPIO_A[24]	BUART_RX / USB1_DP
GPIO_A[25]	BUART_TX / USB1_DM
GPIO_B[5]	ADC0 / WAKEUP
GPIO_B[6]	ADC1 / PWM4 / UART_RX / WAKEUP
GPIO_B[7]	ADC2 / IR1 / PWC1 / PWM5 / UART_TX / WAKEUP
GPIO_B[8]	BUART_RX / PWM6
GPIO_B[20]	PWM7
GPIO_B[22]	ADC3 / PWM5 / WAKEUP
GPIO_B[23]	ADC4 / PWM4 / WAKEUP
GPIO_B[24]	ADC5 / I2S1_LRCK / PCM1_SYNC / PWM3 / WAKEUP
GPIO_B[25]	ADC6 / I2S1_BCLK / PCM1_CLK / PWM2 / WAKEUP
GPIO_B[26]	I2S1_DO / PCM1_DO / PWM1 / TK0
GPIO_B[27]	I2S1_DIN / PCM1_DIN / PWM0 / TK1
GPIO_B[28]	BUART_TX / TK2
GPIO_B[29]	BUART_RX / TK3
GPIO_B[31]	12M_16M_OUT1 / BUART_RTS / TK5
GPIO_C[0]	32K_OUT2 / BUART_CTS / TK_CMPOUT
GPIO_C[11]	LINE2_L(normal quality)
GPIO_C[12]	LINE2_R(normal quality) / SWV
GPIO_C[13]	LINE1_L(normal quality) / SWCLK
GPIO_C[14]	LINE1_R(normal quality) / SWD

Notes.

- ‘TK’ is drive pin for touch key function.
- All GPIOs can be used as external interrupt pins.
- For each of the following modules, only one port group can be activated at any given time, e.g., either USB1 or USB2 can be activated, but not both at the same time.

Module	Port Groups
IR	IR0, IR1
PWC	PWC0, PWC1
USB	USB1, USB2

- For the following modules, there are two scenarios:

Scenario 1, the signal bus can be activated separately, e.g., use UART_TX or UART_RX only;

Scenario 2, only one port can be allocated to the signal bus at any given time, e.g., BUART_TX can be allocated to GPIO_A[25] or GPIO_B[28].

Module	Signal Bus	Ports
UART	UART_TX	GPIO_B[7]
	UART_RX	GPIO_B[6]
BUART	BUART_TX	GPIO_A[25], GPIO_B[28]
	BUART_RX	GPIO_A[24], GPIO_B[8], GPIO_B[29]
	BUART_CTS	GPIO_C[0]
	BUART_RTS	GPIO_B[31]

3. Package

3.1 Package Diagram

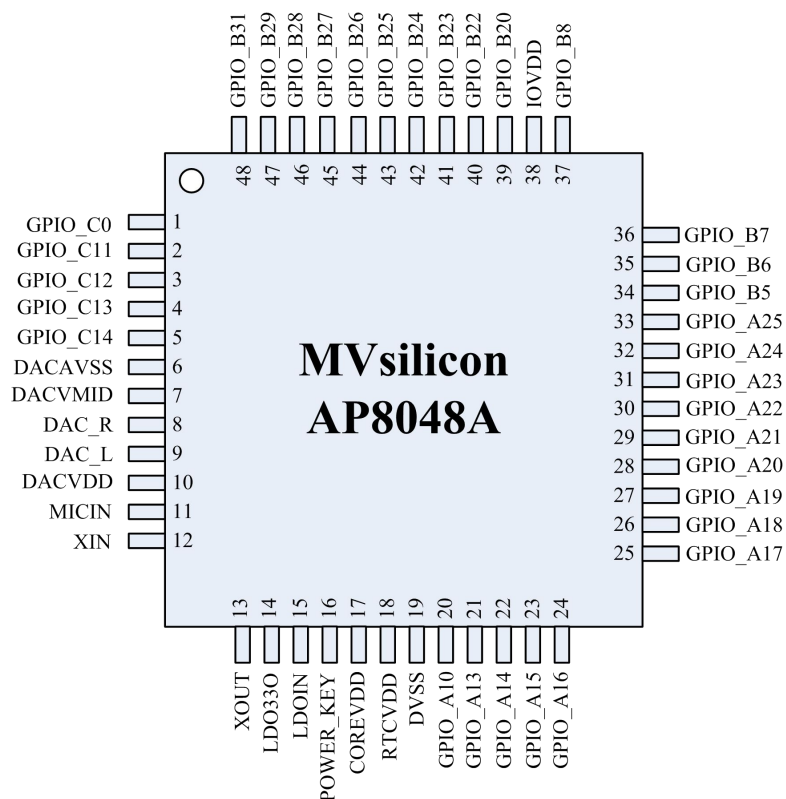


Figure 2 Package Diagram (LQFP48-7x7mm / TOP View)

3.2 Package Dimension Parameter

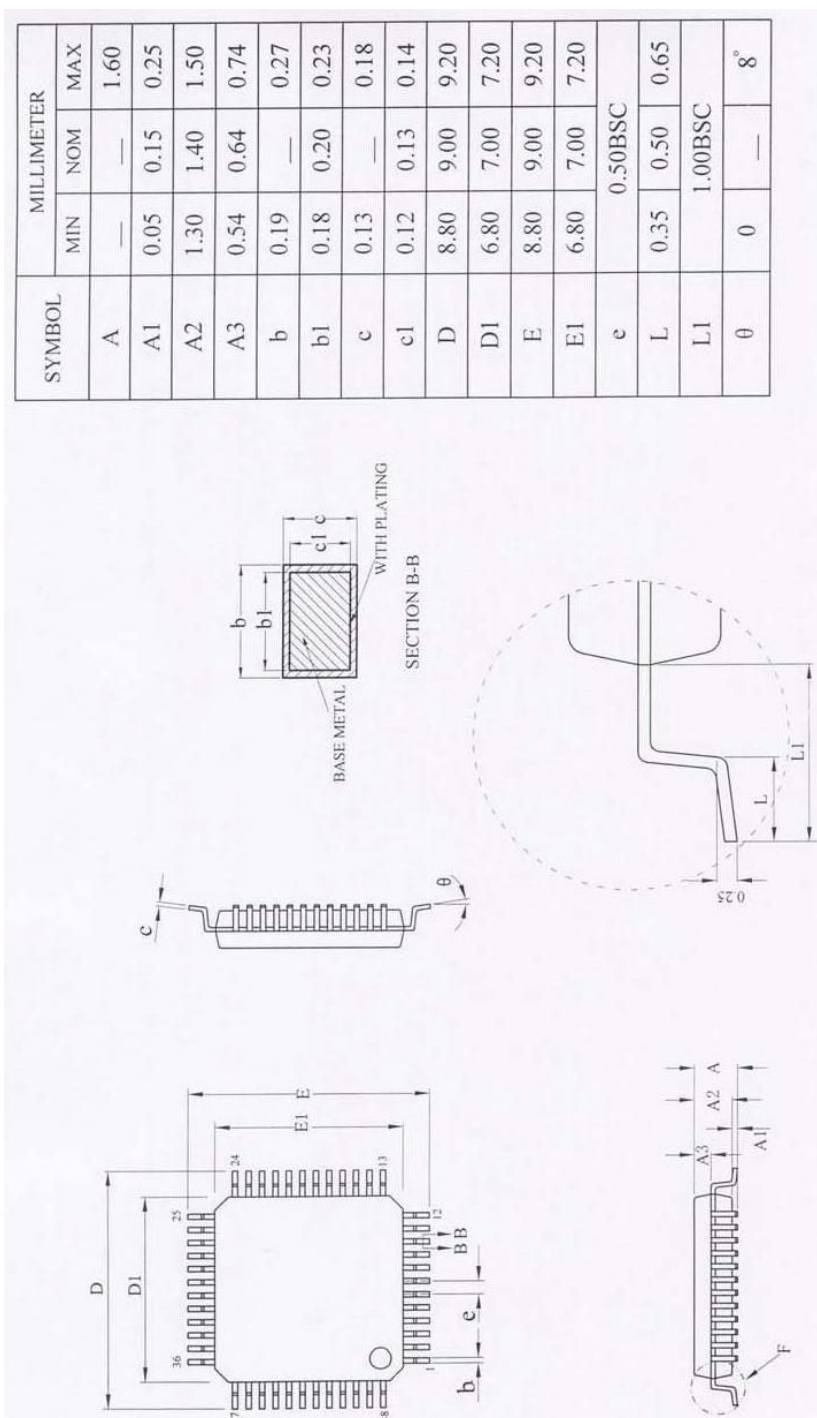


Figure 3 LQFP48-7x7mm Package Dimension Parameter

4. Electrical Specification

4.1 Absolute Maximum Ratings (Note 1)

Table 3 Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Storage Temperature	TEMP_STG	-65 to 150	C

4.2 Recommended Operating Conditions

Table 4 Recommended Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit
Power Supply Voltage	LDOIN	3.35	5.0	5.5	V
IO Input Voltage	VIN	0		3.6	V
Operating Free Air Temperature	TEMP_OPR	-40		85	C

4.3 Electrical Characteristics

Table 5 Electrical Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Unit
VIH	Input High Voltage		1.6		3.6	V
VIL	Input Low Voltage		-0.3		1.4	V
VOH	Output high voltage	@IOH=2mA	3.0			V
VOL	Output low voltage	@IOL=2mA			0.3	V
IL	Input leakage current		-10		10	uA
P_PLAY current	Current consumption when playing	Playing mode		30		mA
RTC current	Current consumption for RTC & NVM			16		uA

4.4 LDO330 driving capability

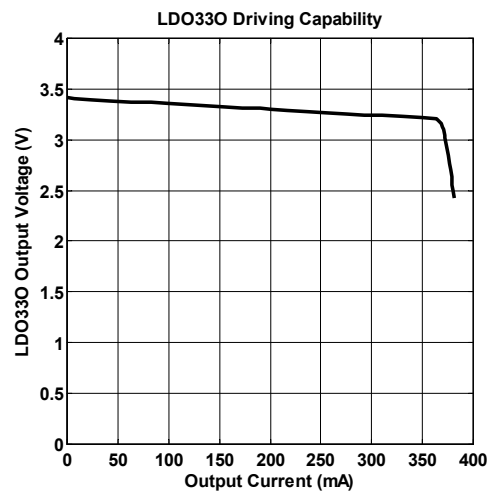


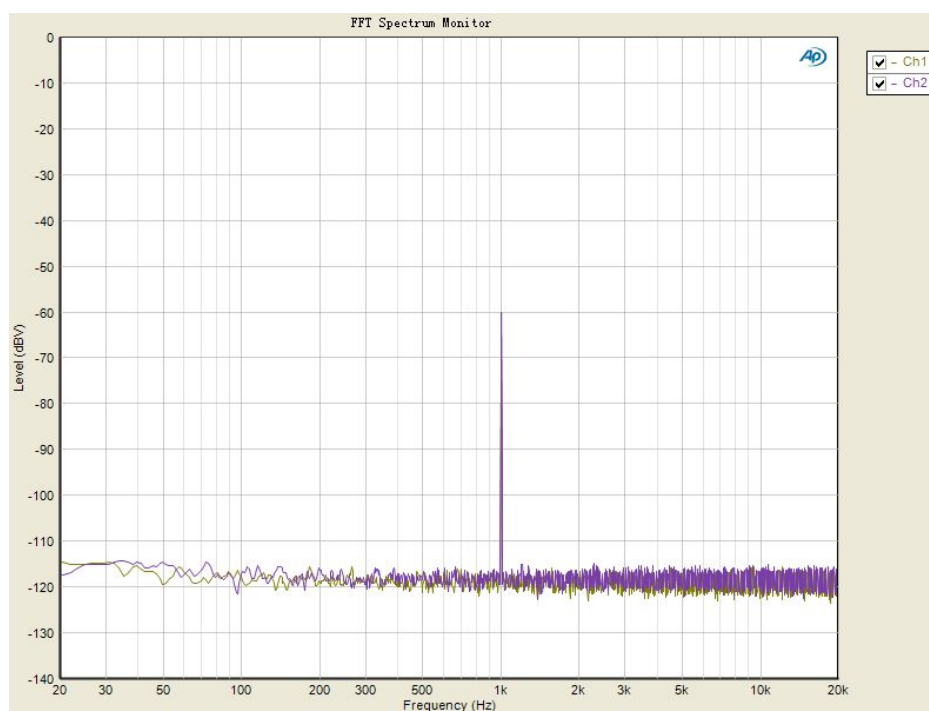
Figure 4 LDO330 driving capability

Note. Not fully tested, characterized only; 2, LDOIN=5V, T_A=25°C

4.5 Audio Performance

Table 6 Audio DAC Performance

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Dynamic Range	No Filter		93.6/93.6		dB
	With A-Weighted Filter		95/95		dB
Signal-to-Noise Ratio	No Filter		95.5/95.6		dB
	With A-Weighted Filter		98/98		dB
THD+N	Peak THD+N (@0dBFS)		-81/-81		dB
	0dBFS		-75/-75		dB
Frequency Response			0.06		dBV
Output Swing			0.993		Vrms
Inter-channel Gain Mismatch			0.003		dB
Volume Control Step			TBD		dB
Volume Control Range			TBD		dB
Group Delay			80		us
Inter-channel Phase Deviation			0.01		degree
Crosstalk			-99/-98		dB



The measured output audio spectrum when the output is at -60 dBV

Table 7 LINE-IN (normal quality) Channel Characteristics

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Dynamic Range	No Filter		86		dB
	With A-Weighted Filter				dB
Signal-to-Noise Ratio	No Filter		85		dB
	With A-Weighted Filter				dB
THD+N	Peak THD+N (@-12dBFS)		-75		dB
Group Delay			26		fs
Power Consumption			7.6		mW
Power Supply Rejection Ratio	1kHz, 300mVrms		55		dB

Table 8 MIC Channel Characteristics

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Dynamic Range	No Filter		87.5/87.5		dB
	With A-Weighted Filter		90/90		dB
Signal-to-Noise Ratio	No Filter		85.5/85.5		dB
	With A-Weighted Filter		88.5/88.5		dB
THD+N	Peak THD+N (@-2dBFS)		-82/-82		dB
Group Delay			26		fs
Crosstalk			TBD		dB
Power Consumption			7.6		mW
Power Supply Rejection Ratio	1kHz, 300mVrms		55		dB

Note:

1. “Absolute Maximum Ratings” are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits.

5. Store and Reflow

AP8048A is a moisture sensitive component. The moisture sensitivity classification is **Class 3**.

It's important that the parts are handled under precaution and a proper manner.

The handling, baking and out-of-pack storage conditions of the moisture sensitive components are described in IPC/JEDC S-STD-033A.

The Technologies recommends utilizing the standard precautions listed below.

1. Calculated shelf life in Sealed Bag: 12 months at $<40^{\circ}\text{C}$ and $<90\%$ relative humidity(RH)
2. Peak Package Body Temperature: 250°C
3. After bag is opened, devices that will be subjected to reflow solder of other high temperature process must be:
 - a. Mounted within 168 hours of factory condition $\leq 30^{\circ}\text{C}$ / 60% RH
 - b. Stored at $<10\%$ RH if not used
4. Devices require baking, before mounting if:
 - a. Humidity indicator card is $>10\%$ when read at $23\pm 5^{\circ}\text{C}$ immediately after moisture barrier bag is opened
 - b. Items 3a or 3b is not met
5. If baking is required, please refer to J-STD-033 standard for low temperature (40°C) baking requirement in Tape/Reel form.

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